# XC61C Series

## Low Voltage Detectors (V$_{DF}$= 0.8V～1.5V)
## Standard Voltage Detectors (V$_{DF}$= 1.6V～6.0V)

⊙ TOREX

◆CMOS

◆Highly Accurate : ±2%

◆Low Power Consumption :0.7μA
(VIN=1.5V)

## ■APPLICATIONS

●Microprocessor reset circuitry
●Memory battery back-up circuits
●Power-on reset circuits
●Power failure detection
●System battery life and charge voltage monitors

## ■GENERAL DESCRIPTION

The XC61C series are highly precise, low power consumption voltage detectors, manufactured using CMOS and laser trimming technologies.

Detect voltage is extremely accurate with minimal temperature drift.

Both CMOS and N-channel open drain output configurations are available.

## ■FEATURES

**Highly Accurate** : ± 2%
**Low Power Consumption** : 0.7μA (TYP.)[ VIN=1.5V ]
**Detect Voltage Range** : 0.8V ~ 1.5V in 100mV increments(Low Voltage)
: 1.6V~6.0V in 100mV increments(Standard Voltage)
**Operating Voltage Range** : 0.7V ~ 6.0V(Low Voltage)
: 0.7V~10.0V(Standard Voltage)
**Detect Voltage Temperature Characteristics**
: ±100ppm/℃ (TYP.)
**Output Configuration** : N-channel open drain or CMOS
**Ultra Small Packages** : SSOT-24 (150mW) super mini-mold
: SOT-23 (150mW) mini-mold
: SOT-89 (500mW) mini-power mold
: TO-92 (300mW)
: USP-6C (100mW)
: USP-4 (140mW)

## ■TYPICAL APPLICATION CIRCUITS
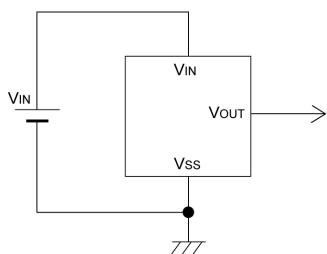
CMOS Output
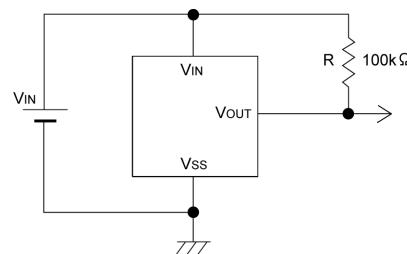
N-ch Open Drain Output

## ■TYPICAL PERFORMANCE CHARACTERISTICS

Supply Current vs. Input Voltage
XC61CC0902 (0.9V)

Supply Current vs. Input Voltage
XC61CC4502 (4.5V)

# XC61C Series

## ■PIN CONFIGURATION



SSOT-24(SC-82)
(TOP VIEW)

SOT-23
(TOP VIEW)
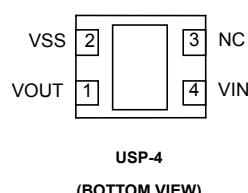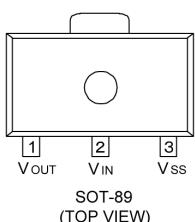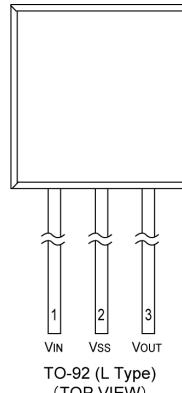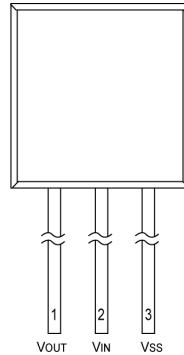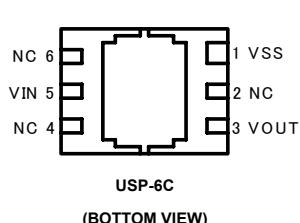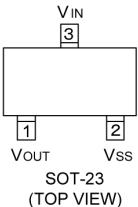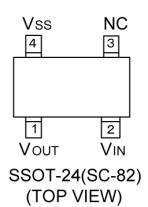
USP-6C
(BOTTOM VIEW)

*Please use the circuit without connecting the heat dissipation pad. If the pad needs to be connected to other pins, it should be connected to the VIN pin.

USP-4
(BOTTOM VIEW)

SOT-89
(TOP VIEW)

TO-92 (T Type)
(TOP VIEW)

TO-92 (L Type)
(TOP VIEW)

## ■PIN ASSIGNMENT

| PIN NUMBER | | | | | | | PIN NAME | FUNCTION |
|---|---|---|---|---|---|---|---|---|
| SSOT-24 | SOT-23 | SOT-89 | TO-92 (T) | TO-92 (L) | USP-6C | USP-4 | | |
| 2 | 3 | 2 | 2 | 1 | 5 | 4 | $V_{IN}$ | Supply Voltage |
| 4 | 2 | 3 | 3 | 2 | 1 | 2 | $V_{SS}$ | Ground |
| 1 | 1 | 1 | 1 | 3 | 3 | 1 | $V_{OUT}$ | Output |
| 3 | - | - | - | - | 2,4,6 | 3 | $N_C$ | No Connection |

## ■PRODUCT CLASSIFICATION

●Ordering Information

XC61C①②③④⑤⑥⑦

| DESIGNATOR | DESCRIPTION | SYMBOL | DESCRIPTION |
|---|---|---|---|
| ① | Output Configuration | C | : CMOS output |
| | | N | : N-ch open drain output |
| ② ③ | Detect Voltage | 08 ~ 60 | : e.g.0.9V → ②0, ③9 |
| | | | : e.g.1.5V → ②1, ③5 |
| ④ | Output Delay | 0 | : No delay |
| ⑤ | Detect Accuracy | 2 | : Within ±2% |
| ⑥ | Package | N | : SSOT-24 (SC-82) |
| | | M | : SOT-23 |
| | | P | : SOT-89 |
| | | T | : TO-92 (Standard) |
| | | L | : TO-92 (Custom pin configuration) |
| | | D | : USP-6C |
| | | G | : USP-4 |
| ⑦ | Device Orientation | R | : Embossed tape, standard feed |
| | | L | : Embossed tape, reverse feed |
| | | H | : Paper type (TO-92) |
| | | B | : Bag (TO-92) |

# ■PACKAGING INFORMATION

●SSOT-24 (SC-82)
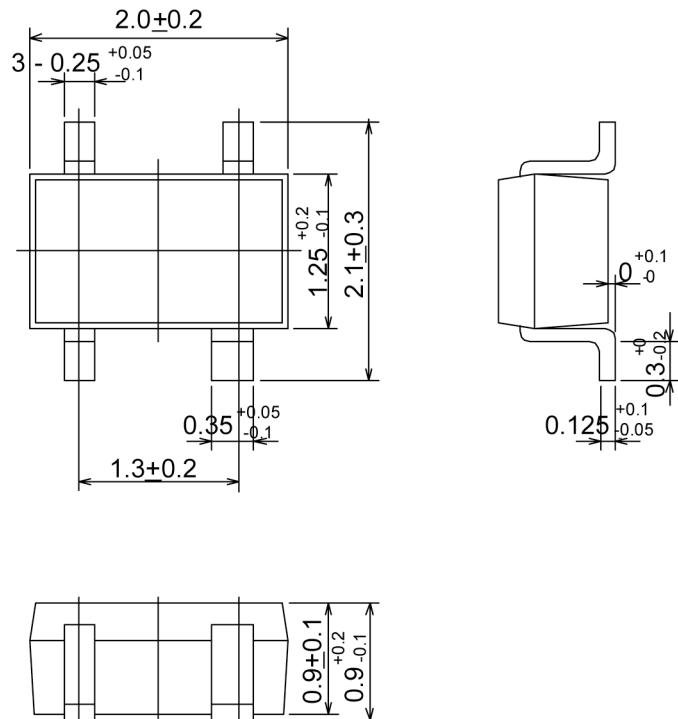


●SOT-23
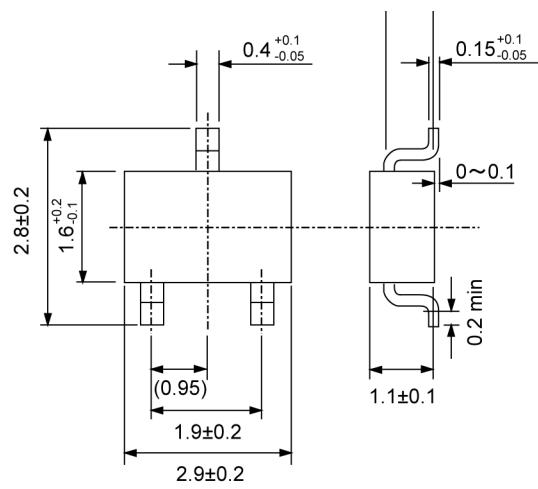
## ■PACKAGING INFORMATION (Continued)

●SOT-89



4.5±0.1

1.6 $^{+0.15}_{-0.2}$

(0.4)

1.5±0.1

2.5±0.1

4.25max

0.8 min

0.42±0.06

0.47±0.06

0.42±0.06

1.5±0.1    1.5±0.1

0.4 $^{+0.03}_{-0.02}$

●TO-92



4.65 $^{+0.35}_{-0.45}$

3.7±0.3

4.8 $^{+0.4}_{-0.5}$

1.6±0.1

10.0min

0.45±0.1

0.4±0.05

2.5 $^{+0.4}_{-0.1}$    2.5 $^{+0.4}_{-0.1}$

# ■PACKAGING INFORMATION (Continued)

● USP-6C



0.30
0.10
0.25
0.10
1.00
1.40
0.50
0.20

* Pin #1 is thicker than other pins.

● USP-4



1.2+0.15
1.6+0.15
MAX 0.6

0.3+0.05
0.2+0.1
0.7+0.1
1.0+0.1
(0.6)

* Soldering fillet surface is not formed because the sides of the pins are plated.

TOREX
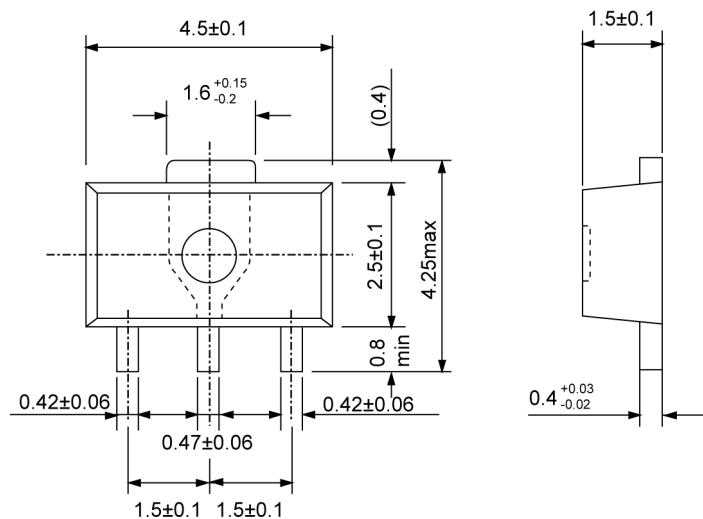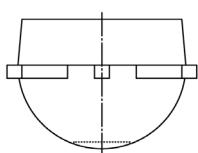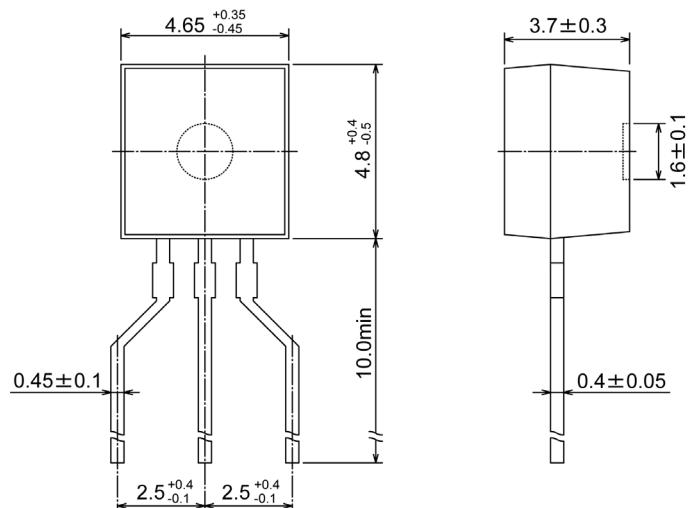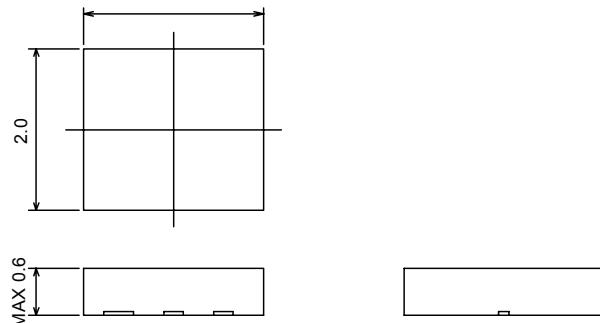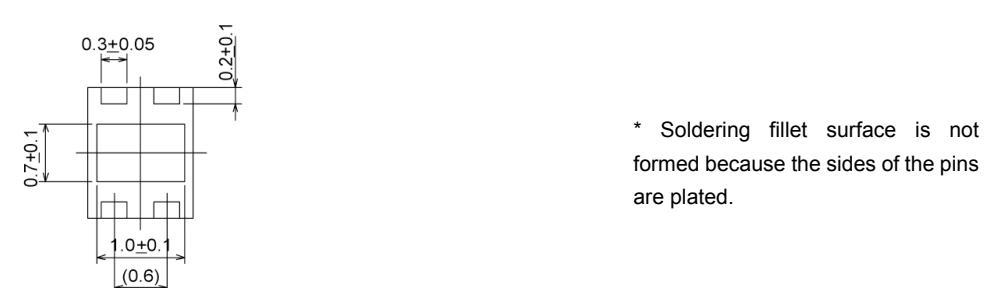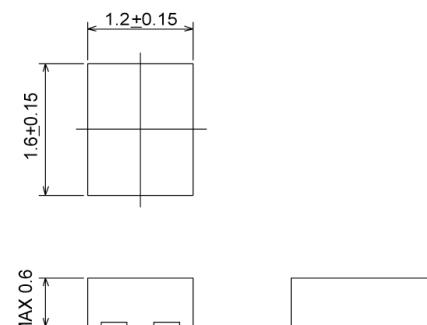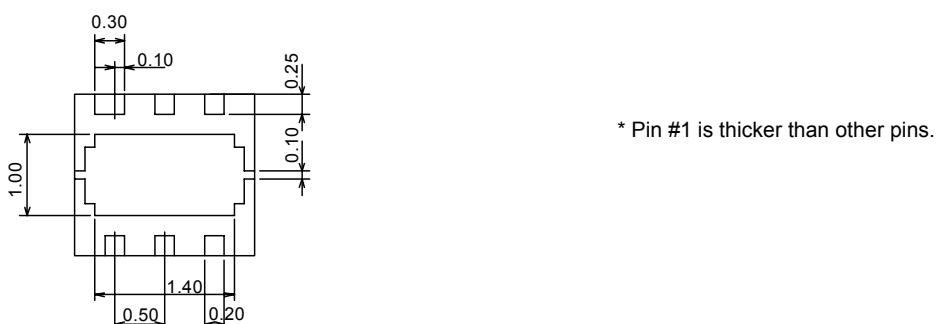
## ■MARKING RULE

●SSOT-24, SOT-23, SOT-89, USP-6C
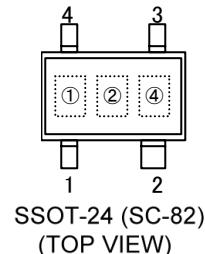
SSOT-24 (SC-82)
(TOP VIEW)
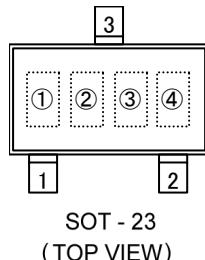
SOT - 23
( TOP VIEW )
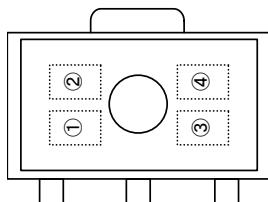
SOT - 89
( TOP VIEW )
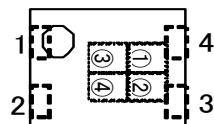
USP-4
(TOP VIEW)

①Represents integer of output voltage and detect voltage
CMOS Output (XC61CC series)

| MARK | CONFIGURATION | VOLTAGE (V) |
|------|---------------|-------------|
| A | CMOS | 0.X |
| B | CMOS | 1.X |
| C | CMOS | 2.X |
| D | CMOS | 3.X |
| E | CMOS | 4.X |
| F | CMOS | 5.X |
| G | CMOS | 6.X |

N-Channel Open Drain Output (XC61CN series)

| MARK | CONFIGURATION | VOLTAGE (V) |
|------|---------------|-------------|
| K | N-ch | 0.X |
| L | N-ch | 1.X |
| M | N-ch | 2.X |
| N | N-ch | 3.X |
| P | N-ch | 4.X |
| R | N-ch | 5.X |
| S | N-ch | 6.X |

②Represents decimal number of detect voltage

| MARK | VOLTAGE (V) | MARK | VOLTAGE (V) |
|------|-------------|------|-------------|
| 0 | X.0 | 5 | X.5 |
| 1 | X.1 | 6 | X.6 |
| 2 | X.2 | 7 | X.7 |
| 3 | X.3 | 8 | X.8 |
| 4 | X.4 | 9 | X.9 |

③Based on internal standard
   (except for SSOT-24)

| MARK |
|------|
| 3 |

④Represents production lot number
   0 to 9, A to Z repeated.   (G, I, J, O, Q, W excepted)

# ■MARKING RULE (Continued)

●TO-92



TO-92 （L Type）
(TOP VIEW)

TO-92 （T Type）
(TOP VIEW)
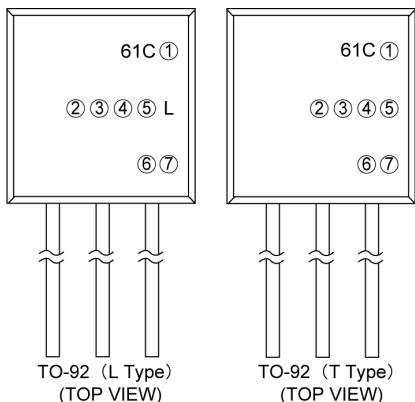
①Represents output configuration

| MARK | OUTPUT CONFIGURATION |
|---|---|
| C | CMOS |
| N | N-ch |

②③Represents detect voltage

| MARK | | VOLTAGE (V) |
|---|---|---|
| ② | ③ | |
| 0 | 9 | 0.9 |
| 1 | 5 | 1.5 |

④Represents delay time

| DESIGNATOR | DELAY TIME |
|---|---|
| 0 | No delay |

⑤Represents detect voltage accuracy

| MARK | DETECT VOLTAGE ACCURACY |
|---|---|
| 2 | Within ± 2% |

⑥Represents a least significant digit of production year

| MARK | PRODUCTION YEAR |
|---|---|
| 3 | 2003 |
| 4 | 2004 |

⑦Represents production lot number
  0 to 9, A to Z repeated
  (G, I, J, O, Q, W excepted)

●USP-6C



USP-6C
(TOP VIEW)
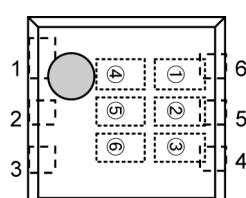
①, ②　Represents product series

| MARK | | PRODUCT SERIES |
|---|---|---|
| ① | ② | |
| 1 | C | XC61Cxxx0xDx |

③　Represents output configuration

| MARK | OUTPUT CONFIGURATION | PRODUCT SERIES |
|---|---|---|
| C | CMOS | XC61CCxx0xDx |
| N | N-ch | XC61CNxx0xDx |

④, ⑤Represents detect voltage
(example)

| MARK | | VOLTAGE (V) | PRODUCT SERIES |
|---|---|---|---|
| ④ | ⑤ | | |
| 3 | 3 | 3.3 | XC61Cx330xDx |
| 5 | 0 | 5.0 | XC61Cx500xDx |

⑥　Represents production lot number
  0 to 9, A to Z repeated (G, I, J, O, Q, W excepted)
  Note: No character inversion used.

# XC61C Series

## ■BLOCK DIAGRAMS

(1) CMOS Output
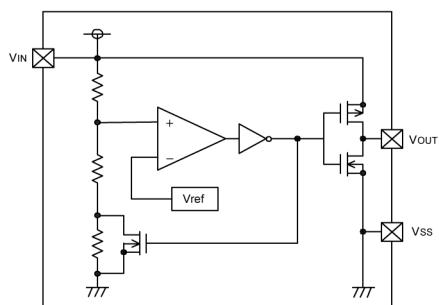
(2) N-ch Open Drain Output
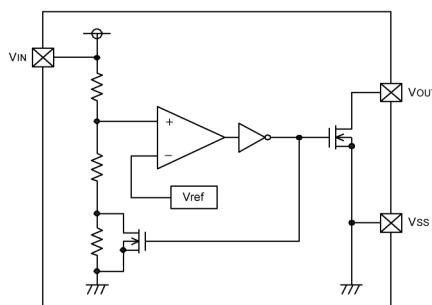
## ■ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

| PARAMETER | | | SYMBOL | RATINGS | UNITS |
|---|---|---|---|---|---|
| Input Voltage | | *1 | VIN | 9.0 | V |
| | | *2 | | 12.0 | |
| Output Current | | *1 | IOUT | 50 | mA |
| | | *2 | | 50 | |
| Output Voltage | CMOS | | VOUT | VSS -0.3 ~ VIN +0.3 | V |
| | N-ch Open Drain Output *1 | | | VSS -0.3 ~ 9.0 | |
| | N-ch Open Drain Output *2 | | | VSS -0.3 ~ 12.0 | |
| Power Dissipation | SSOT-24 | | Pd | 150 | mW |
| | SOT-23 | | | 150 | |
| | SOT-89 | | | 500 | |
| | TO-92 | | | 300 | |
| | USP-6C | | | 100 | |
| | USP-4 | | | 140** | |
| Operating Temperature Range | | | Topr | -40～+85 | °C |
| Storage Temperature Range | | | Tstg | -40～+125 | °C |

*1: Low voltage

*2: Standard voltage

**When mounted on glass epoxy.

# ■ELECTRICAL CHARACTERISTICS

VDF (T) = 0.9 to 1.5V ± 2%

Ta=25℃

| PARAMETER | SYMBOL | CONDITIONS | | MIN. | TYP. | MAX. | UNITS | CIRCUITS |
|---|---|---|---|---|---|---|---|---|
| Detect Voltage | VDF | | | VDF x 0.98 | VDF | VDF x 1.02 | V | 1 |
| Hysteresis Range | VHYS | | | VDF x 0.02 | VDF x 0.05 | VDF x 0.08 | V | 1 |
| Supply Current | ISS | | VIN = 1.5V | - | 0.7 | 2.3 | μA | 2 |
| | | | = 2.0V | - | 0.8 | 2.7 | | |
| | | | = 3.0V | - | 0.9 | 3.0 | | |
| | | | = 4.0V | - | 1.0 | 3.2 | | |
| | | | = 5.0V | - | 1.1 | 3.6 | | |
| Operating Voltage | VIN | Low Voltage: VDF(T) = 0.8V to 1.5V | | 0.7 | - | 6.0 | V | 1 |
| | | Standard Voltage: VDF(T) = 1.6V to 6.0V | | 0.7 | - | 10.0 | | |
| Output Current (Low Voltage) | IOUT | N-ch VDS = 0.5V | VIN = 0.7V | 0.10 | 0.80 | - | mA | 3 |
| | | | VIN = 1.0V | 0.85 | 2.70 | - | | |
| | | CMOS, P-ch VDS = 2.1V | VIN = 6.0V | - | -7.5 | -1.5 | | 4 |
| Output Current (Standard Voltage) | | N-ch VDS = 0.5V | VIN = 1.0V | 1.0 | 2.2 | - | | 3 |
| | | | VIN = 2.0V | 3.0 | 7.7 | - | | |
| | | | VIN = 3.0V | 5.0 | 10.1 | - | | |
| | | | VIN = 4.0V | 6.0 | 11.5 | - | | |
| | | | VIN = 5.0V | 7.0 | 13.0 | - | | |
| | | CMOS, P-ch VDS = 2.1V | VIN = 8.0V | - | -10.0 | -2.0 | | 4 |
| Temperature Characteristics | $\dfrac{\Delta VDF}{\Delta Topr \cdot VDF}$ | -40℃ ≦ Topr ≦ 85℃ | | - | ±100 | - | ppm/℃ | - |
| Delay Time (VDR → VOUT inversion) | tDLY | | | - | 0.03 | 0.2 | ms | 5 |

NOTE :
VDF (T) : Setting detect voltage
Release Voltage : VDR = VDF + VHYS

**TOREX**

# XC61C Series

## ■OPERATIONAL EXPLANATION

### ●CMOS output

① When input voltage ($V_{IN}$) rises above detect voltage ($V_{DF}$), output voltage ($V_{OUT}$) will be equal to $V_{IN}$.
(A condition of high impedance exists with N-ch open drain output configurations.)

② When input voltage ($V_{IN}$) falls below detect voltage ($V_{DF}$), output voltage ($V_{OUT}$) will be equal to the ground voltage ($V_{SS}$) level.

③ When input voltage ($V_{IN}$) falls to a level below that of the minimum operating voltage ($V_{MIN}$), output will become unstable. In this condition, $V_{IN}$ will equal the pulled-up output (should output be pulled-up.)

④ When input voltage ($V_{IN}$) rises above the ground voltage ($V_{SS}$) level, output will be unstable at levels below the minimum operating voltage ($V_{MIN}$). Between the $V_{MIN}$ and detect release voltage ($V_{DR}$) levels, the ground voltage ($V_{SS}$) level will be maintained.

⑤ When input voltage ($V_{IN}$) rises above detect release voltage ($V_{DR}$), output voltage ($V_{OUT}$) will be equal to $V_{IN}$.
(A condition of high impedance exists with N-ch open drain output configurations.)

⑥ The difference between $V_{DR}$ and $V_{DF}$ represents the hysteresis range.

### ●Timing Chart
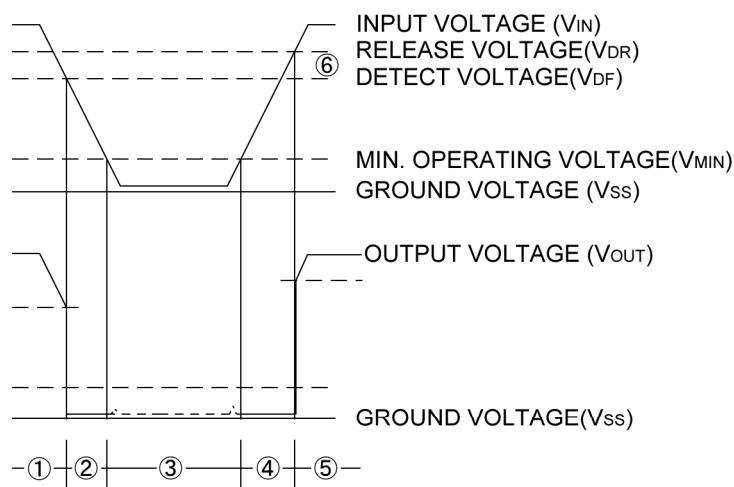
# ■NOTES ON USE

1. Please use this IC within the stated maximum ratings. Operation beyond these limits may cause degrading or permanent damage to the device.
2. When a resistor is connected between the $V_{IN}$ pin and the input with CMOS output configurations, oscillation may occur as a result of voltage drops at $R_{IN}$ if load current ($I_{OUT}$) exists. (refer to the Oscillation Description (1) below)
3. When a resistor is connected between the $V_{IN}$ pin and the input with CMOS output configurations, irrespective of N-ch output configurations, oscillation may occur as a result of through current at the time of voltage release even if load current ($I_{OUT}$) does not exist. (refer to the Oscillation Description (2) below )
4. With a resistor connected between the $V_{IN}$ pin and the input, detect and release voltage will rise as a result of the IC's supply current flowing through the $V_{IN}$ pin.
5. In order to stabilize the IC's operations, please ensure that $V_{IN}$ pin's input frequency's rise and fall times are more than several μ sec / V.
6. Please use N-ch open drains configuration, when a resistor $R_{IN}$ is connected between the $V_{IN}$ pin and power source.
   In such cases, please ensure that $R_{IN}$ is less than 10kΩ and that C is more than 0.1μF.
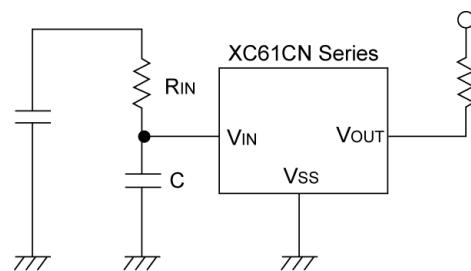


Figure 1: Circuit using an input resistor

## ●Oscillation Description

(1) Output current oscillation with the CMOS output configuration
   When the voltage applied at IN rises, release operations commence and the detector's output voltage increases. Load current ($I_{OUT}$) will flow at $R_L$. Because a voltage drop ($R_{IN}$ x $I_{OUT}$) is produced at the $R_{IN}$ resistor, located between the input (IN) and the $V_{IN}$ pin, the load current will flow via the IC's $V_{IN}$ pin. The voltage drop will also lead to a fall in the voltage level at the $V_{IN}$ pin. When the $V_{IN}$ pin voltage level falls below the detect voltage level, detect operations will commence. Following detect operations, load current flow will cease and since voltage drop at $R_{IN}$ will disappear, the voltage level at the $V_{IN}$ pin will rise and release operations will begin over again.
   Oscillation may occur with this " release - detect - release " repetition.
   Further, this condition will also appear via means of a similar mechanism during detect operations.

(2) Oscillation as a result of through current
   Since the XC61C series are CMOS IC s, through current will flow when the IC's internal circuit switching operates ( during release and detect operations ). Consequently, oscillation is liable to occur as a result of drops in voltage at the through current's resistor ($R_{IN}$) during release voltage operations. (refer to Figure 3 )
   Since hysteresis exists during detect operations, oscillation is unlikely to occur.
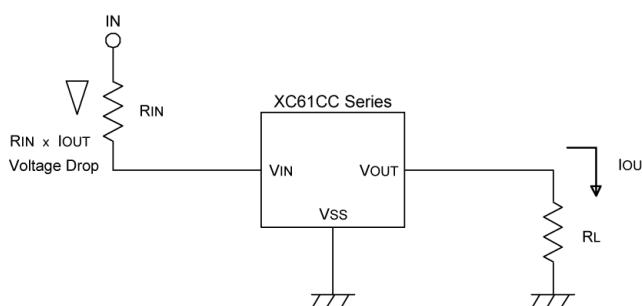


Figure 2: Oscillation in relation to output current
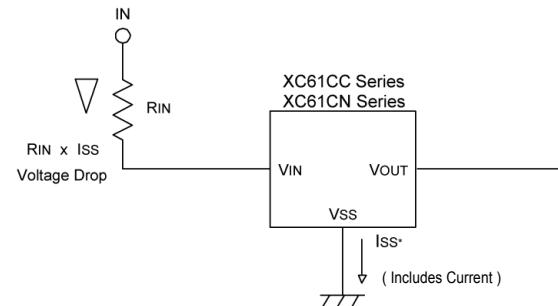
Figure 3: Oscillation in relation to through current

## ■ TEST CIRCUITS

Circuit 1
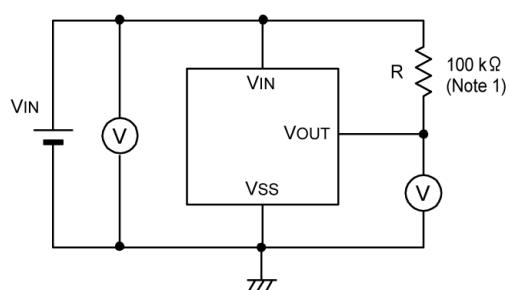
Circuit 2
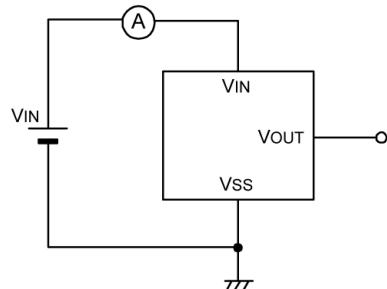
Circuit 3
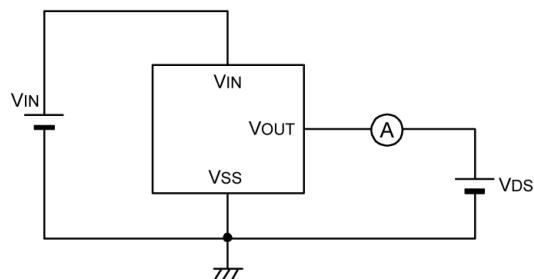
Circuit 4
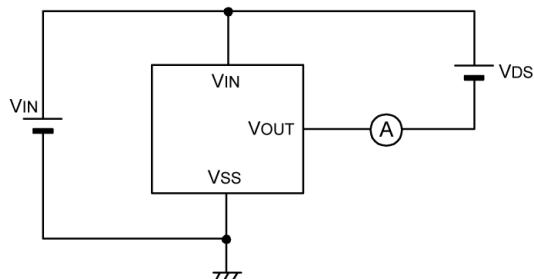
Circuit 5
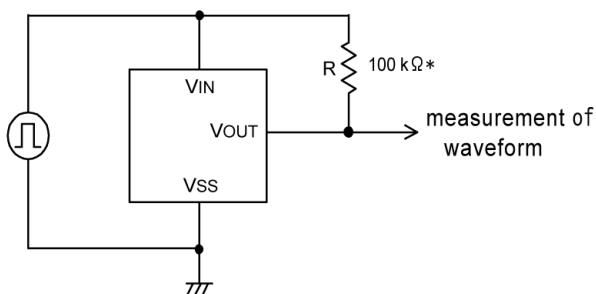
* : A resistor is not necessary with CMOS output products.

# ■TYPICAL PERFORMANCE CHARACTERISTICS

● Low Voltage

(1) Supply Current vs. Input Voltage
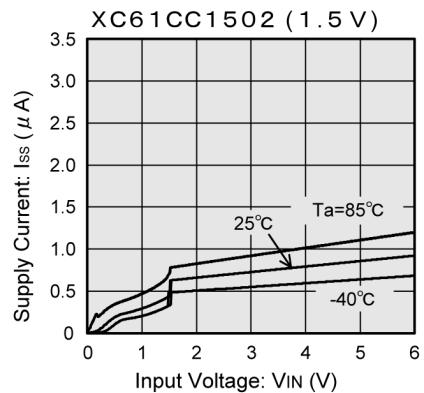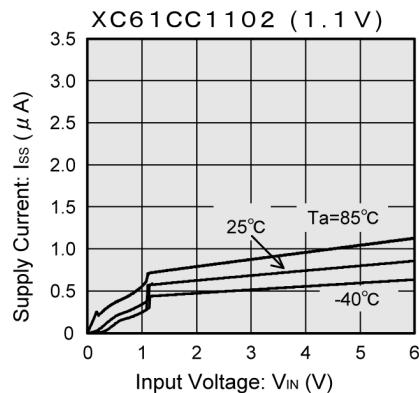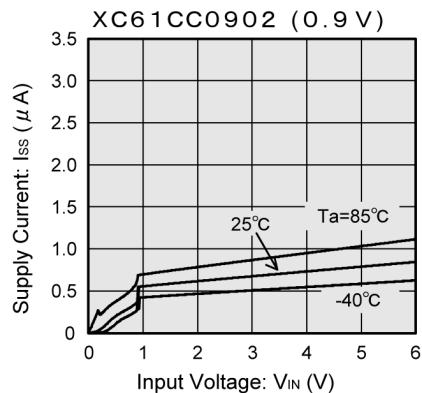
XC61CC0902 (0.9V)

XC61CC1102 (1.1V)

XC61CC1502 (1.5V)

(2) Detect, Release Voltage vs. Ambient Temperature

XC61CC0902 (0.9V)

XC61CC1102 (1.1V)

XC61CC1502 (1.5V)

(3) Output Voltage vs. Input Voltage

XC61CN0902 (0.9V)

XC61CN1102 (1.1V)

XC61CN1502 (1.5V)
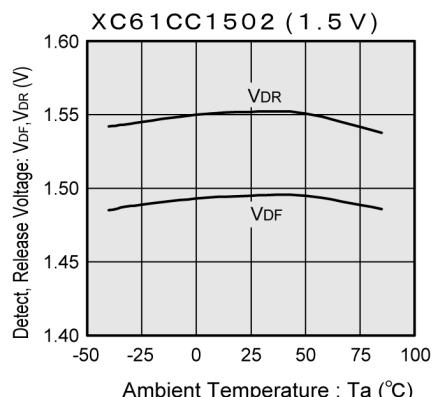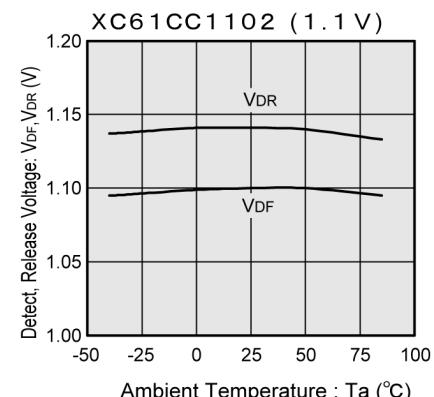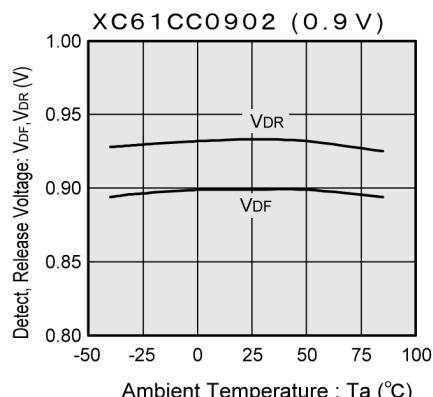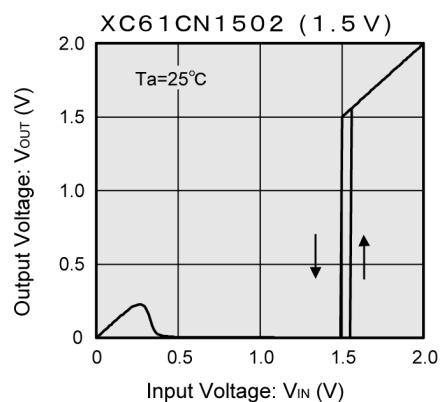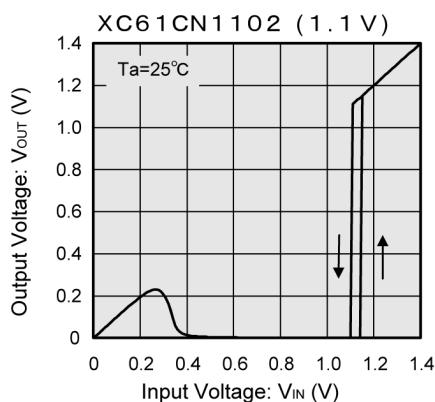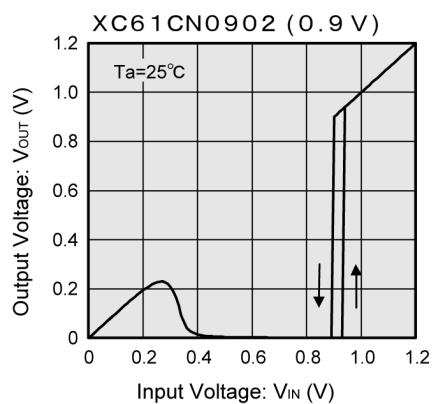
Note : Unless otherwise stated, the N-channel open drain pull-up resistance value is 100kΩ.

## ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### ●Low Voltage (Continued)
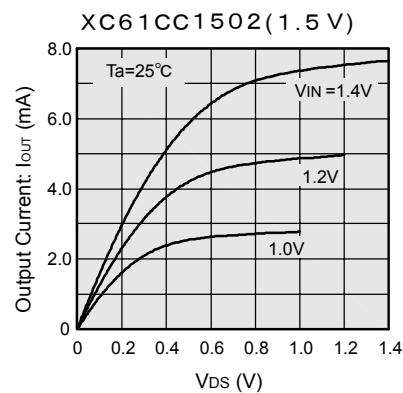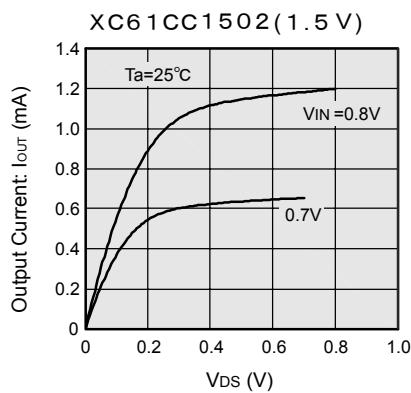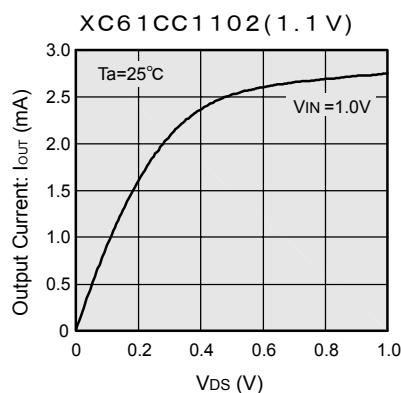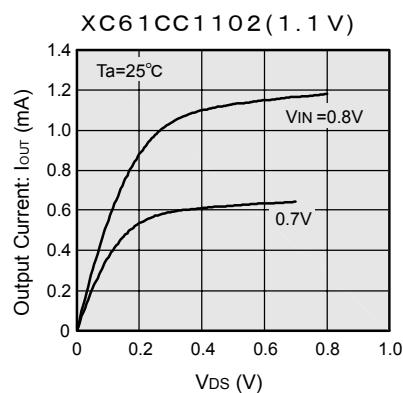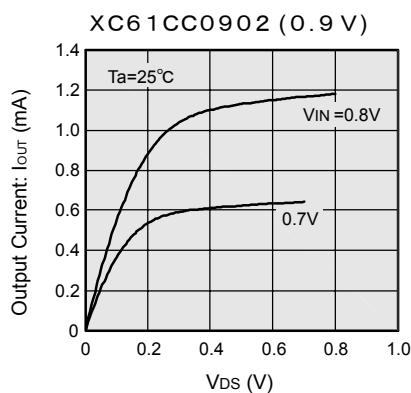
#### (4) N-ch Driver Output Current vs. VDS

XC61CC0902 (0.9 V)

XC61CC1102 (1.1 V)

XC61CC1102 (1.1 V)

XC61CC1502 (1.5 V)

XC61CC1502 (1.5 V)

#### (5) N-ch Driver Output Current vs. Input Voltage

XC61CC0902 (0.9 V)

XC61CC1102 (1.1 V)

XC61CC1502 (1.5 V)

#### (6) P-ch Driver Output Current vs. Input Voltage

XC61CC0902 (0.9 V)

XC61CC1102 (1.1 V)

XC61CC1502 (1.5 V)
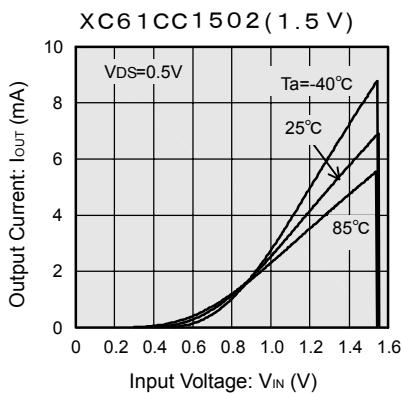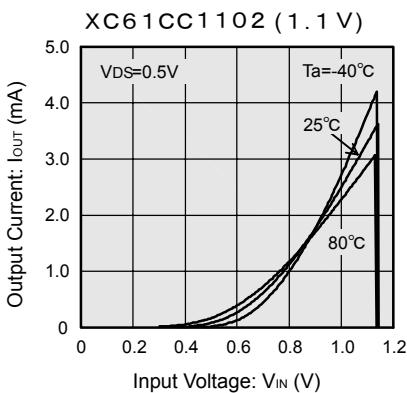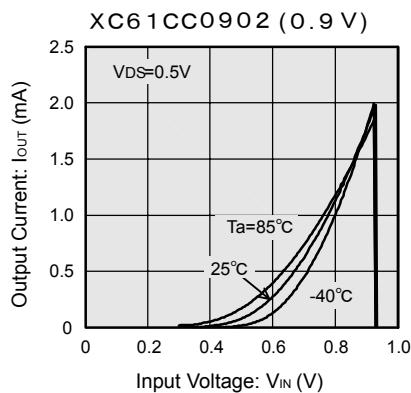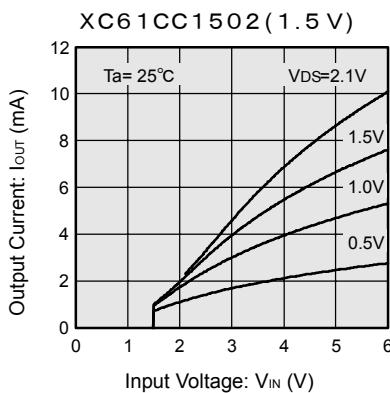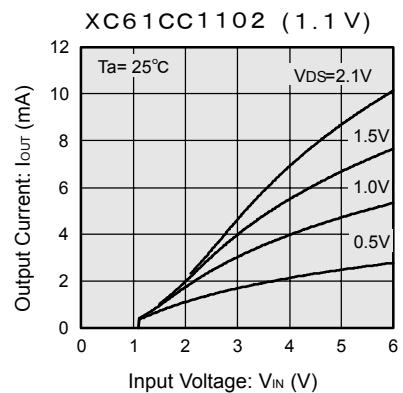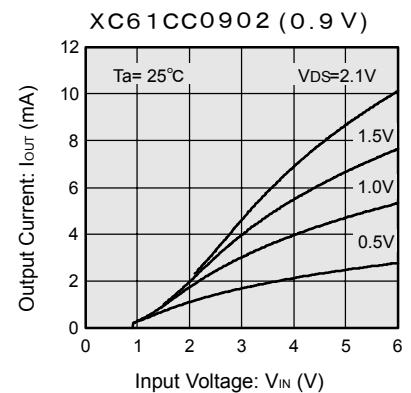
# ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

## ●Standard Voltage

### (1) Supply Current vs. Input Voltage
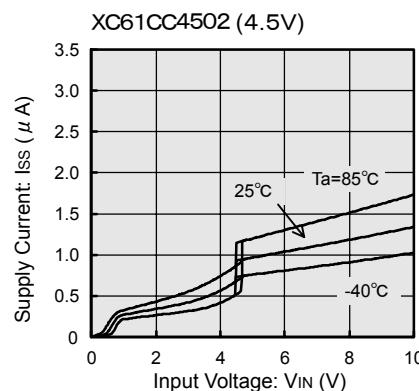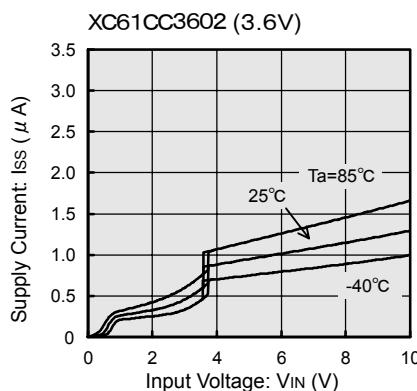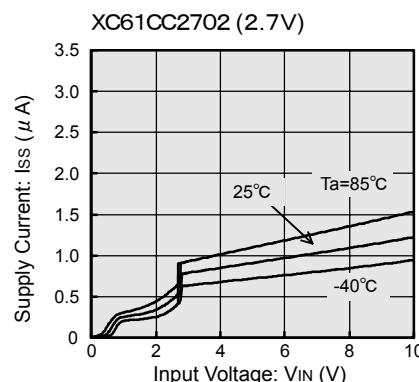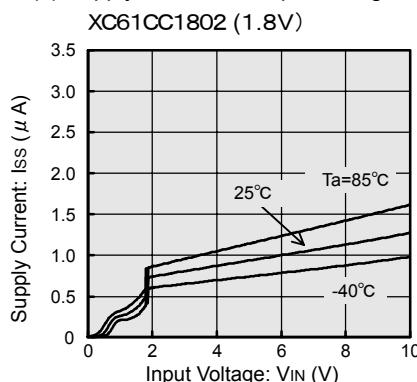
XC61CC1802 (1.8V)

XC61CC2702 (2.7V)

XC61CC3602 (3.6V)

XC61CC4502 (4.5V)

### (2) Detect, Release Voltage vs. Ambient Temperature

XC61CC1802 (1.8V)

XC61CC2702 (2.7V)

XC61CC3602 (3.6V)

XC61CC4502 (4.5V)

**TOREX**
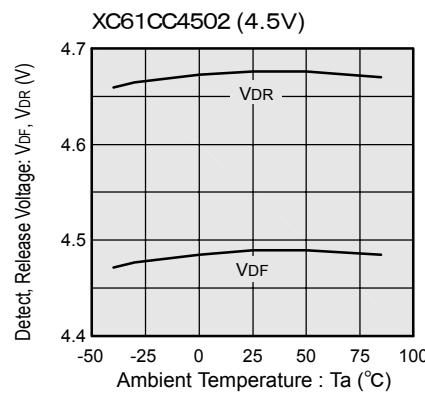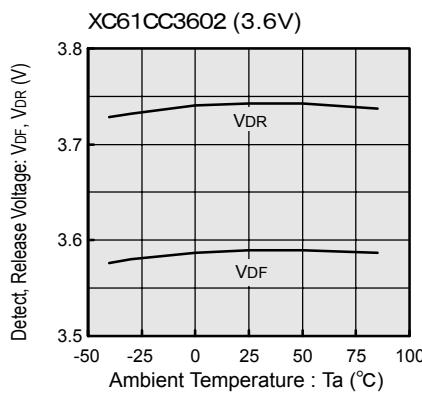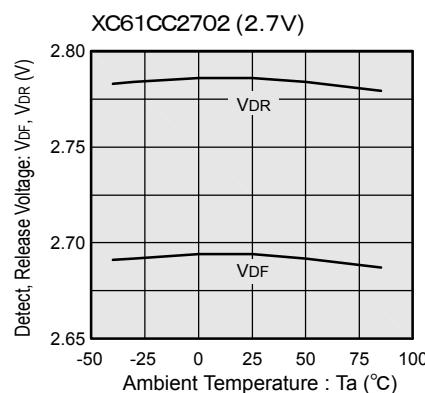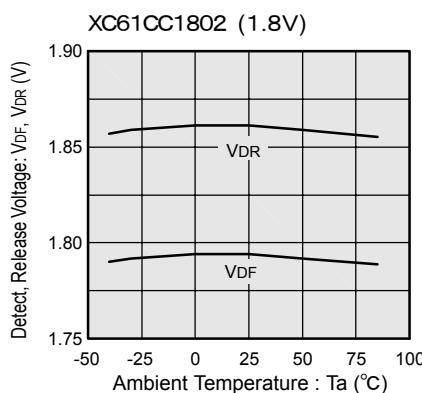
## ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### ●Standard Voltage (continued)

(3) Output Voltage vs. Input Voltage

XC61CN1802 (1.8V)



XC61CN2702 (2.7V)



XC61CN3602 (3.6V)



XC61CN4502 (4.5V)
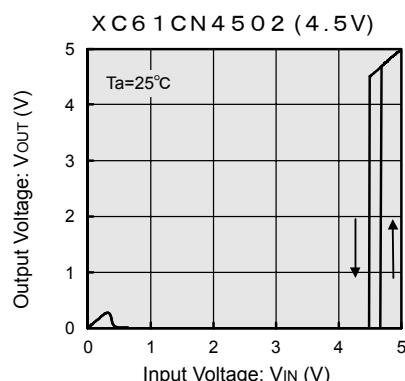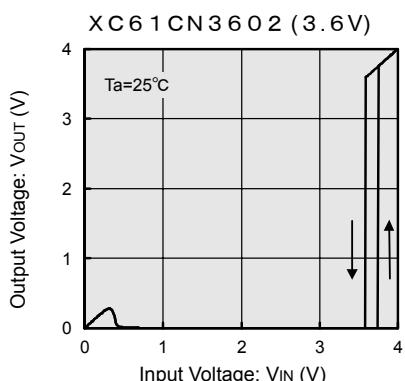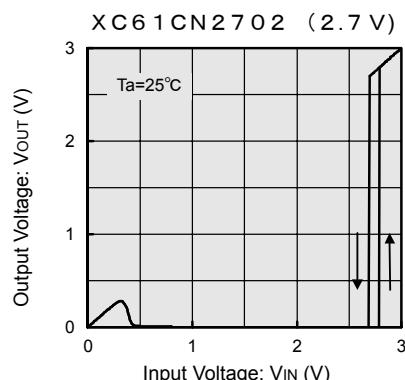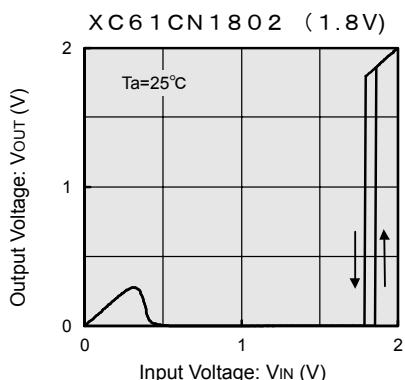


Note : The N-channel open drain pull up resistance value is 100kΩ.

(4) N-ch Driver Output Current vs. $V_{DS}$
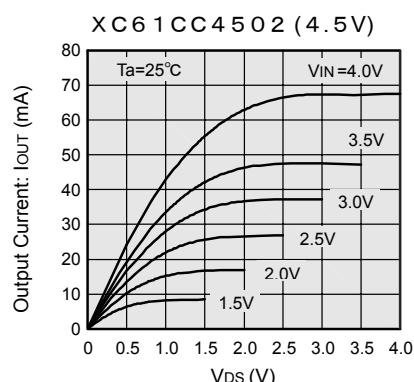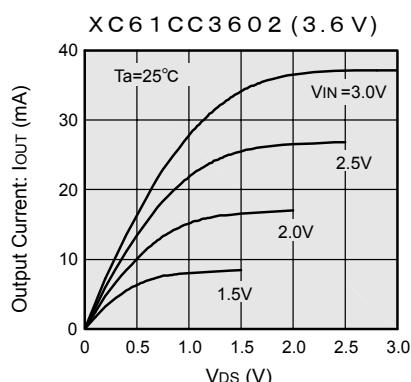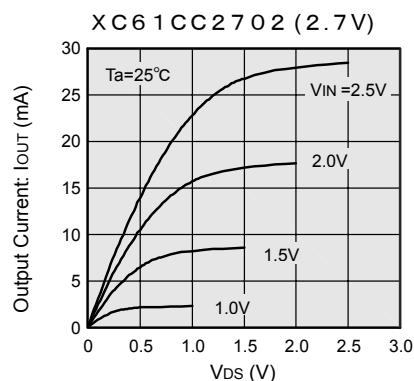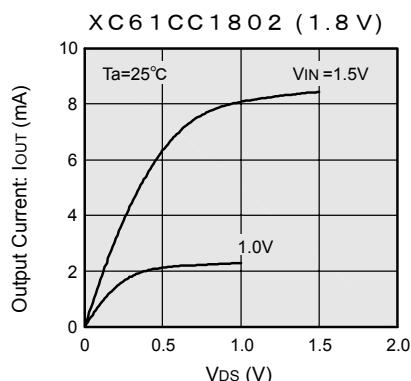
XC61CC1802 (1.8V)



XC61CC2702 (2.7V)



XC61CC3602 (3.6V)



XC61CC4502 (4.5V)

# ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

## ●Standard Voltage (continued)

### (4) N-ch Driver Output Current vs. $V_{DS}$

XC61CC1802 (1.8V)

Ta=25℃  $V_{IN}$=0.8V  0.7V

XC61CC2702 （2.7V)

Ta=25℃  $V_{IN}$=0.8V  0.7V

XC61CC3602 (3.6V)

Ta=25℃  $V_{IN}$=0.8V  0.7V

XC61CC4502 (4.5V)

Ta=25℃  $V_{IN}$=0.8V  0.7V

### (5) N-ch Driver Output Current vs. Input Voltage

XC61CC1802 (1.8V)

$V_{DS}$=0.5V  Ta=-40℃  25℃  85℃

XC61CC2702 (2.7V)

$V_{DS}$=0.5V  Ta=-40℃  25℃  85℃

XC61CC3602 (3.6V)

$V_{DS}$=0.5V  Ta=-40℃  25℃  85℃

XC61CC4502 (4.5V)

$V_{DS}$=0.5V  Ta=-40℃  25℃  85℃

**TOREX**

# XC61C Series
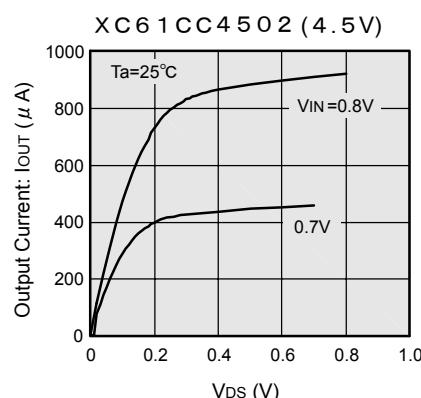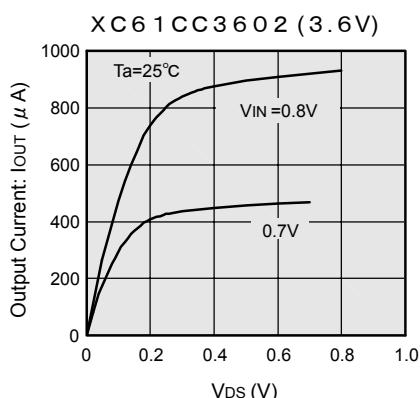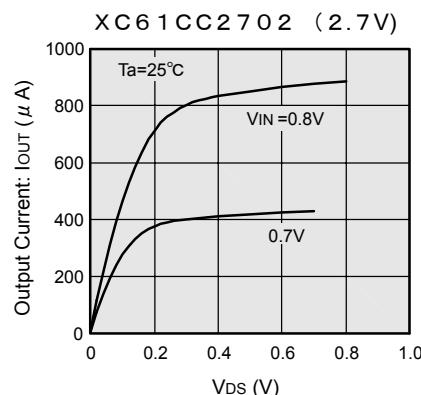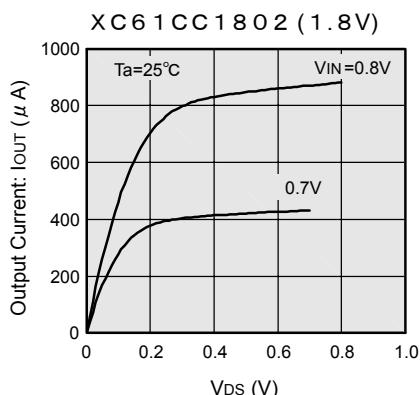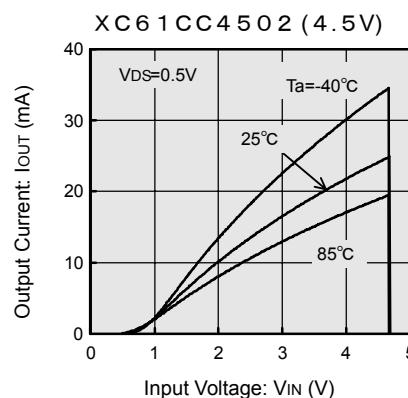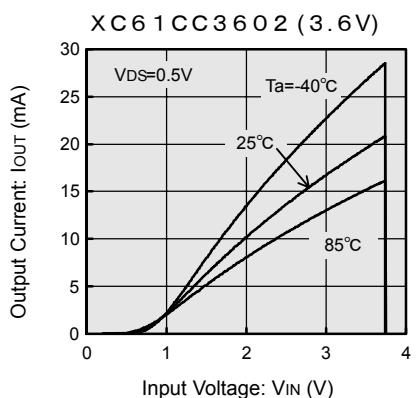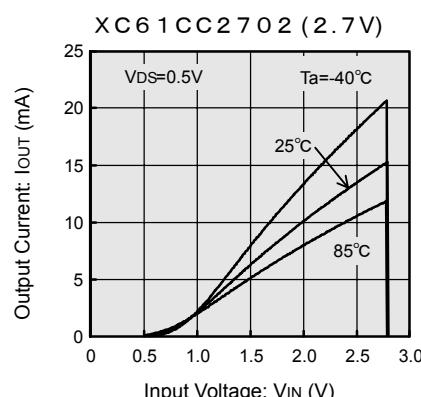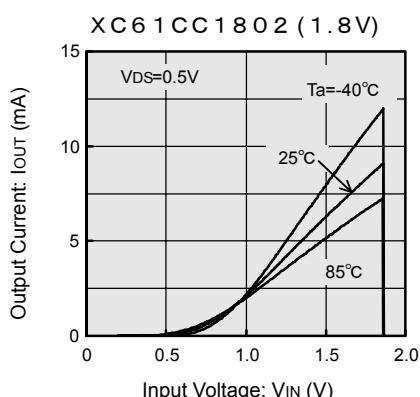
## ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### ●Standard Voltage (continued)

(6) P-ch Driver Output Current vs. Input Voltage

XC61CC1802 (1.8V)

XC61CC2702 (2.7V)

XC61CC3602 (3.6V)

XC61CC4502 (4.5V)